



Models

Model	Input Voltage (DC V)	Input Voltage range (DC V)	Output voltage (DC V)	Output current (mA)
MSD15-2412	24	18~36	±12	± 600
MSD15-2415	24		±15	± 500
MSD15-4812	48	36~75	±12	± 600
MSD15-4815	48		±15	± 500

Specification

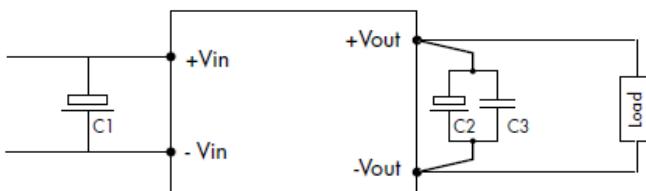
Input Specifications	
Input current (no load)	24 Vin models: 50 mA typ.. 48 Vin models: 30 mA typ.
Input current (full load)	24 Vin; 3.3 Vout models: 570 mA typ. 24 Vin; other output models: 730 mA typ. 48 Vin; 3.3 Vout models: 280 mA typ. 48 Vin; other output models: 360 mA typ.
Start-up voltage /under voltage shut down	24 Vin models: 17 VDC /16.5 VDC 48 Vin models: 34.0 VDC /32.5 VDC
Surge voltage(100 msec. max.)	24 Vin models: 50 V max.. 48 Vin models: 100 V max.

Output Specifications		
Voltage set accuracy		$\pm 1\%$
Regulation	<ul style="list-style-type: none"> - Input variation V_{in} min. to V_{in} max 0.5% max. - Load variation 10 – 100 % 	dual output models unbalanced: 2.0 % max. dual output models unbalanced: 5.0 % max.
Ripple and noise (20 MHz Bandwidth)		100 mVpk-pk max. (with external output capacitor, see Note 1)
Temperature coefficient		$\pm 0.02\% /K$
Output current limitation		>105% of I_{out} max., foldback
Short circuit protection		indefinite (automatic recovery)
Start-up time		30ms max.
Max. capacitive load		1200 μF
General Specifications		
Temperature ranges	<ul style="list-style-type: none"> - Operating $-25^\circ C \dots +71^\circ C$ - Derating 2.5%/K above $50^\circ C$ - Case temperature $+100^\circ C$ max. - Storage $-40^\circ C \dots +110^\circ C$ 	
Humidity (non condensing)		85 % rel H max.
Reliability, calculated MTBF (MIL-HDBK-217F ground b) > 190'000h @ $+25^\circ C$		
Isolation voltage (60sec)	- Input/Output	1'500 VDC
Isolation capacity	- Input/Output	235 pF typ.
Isolation resistance	- Input/Output (500 VDC)	>100 M Ohm
Switching frequency (fixed)		330 kHz typ. (Pulse width modulation PWM)
Remote On/Off	<ul style="list-style-type: none"> - On: open circuit on pin RC - Off: short circuit between pin RC and pin $-V_{in}$ 	

Physical Specifications	
Case material	plastic PBT (UL94V-0 rated)
Baseplate	non conductive FR4
Potting material	silicon (UL94V-0 rated)
Weight	12 g (0.41 oz)
Soldering temperature	max. $265^\circ C / 10sec.$

Note 1

Recommended circuit to reduce conducted noise and output ripple & noise:

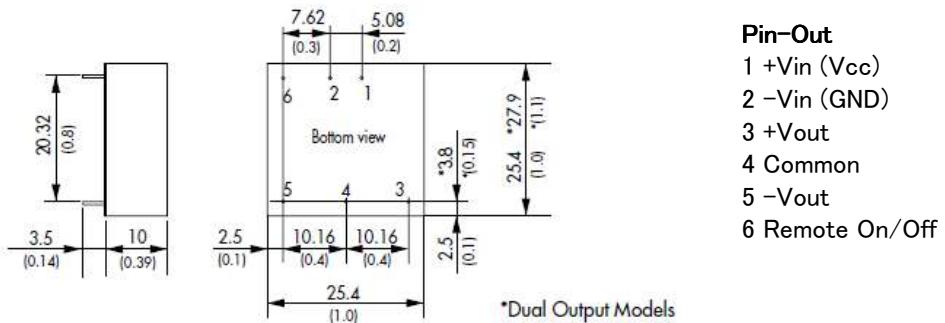


C1: 33 μF low ESR electrolytic capacitor

For dual output models use capacitors for each output C2: 10 μF low ESR electrolytic capacitor

C3: 1 μ film capacitor

Outline Dimensions mm



() = Inch